

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	
CD-ROM or CD_R?::	None
Number of CD disks::	
Number of copies of CDs::	
Sequence Submission::	No
Computer Readable Form (CRF)?::	No
Title::	CIRCUIT BOARD ELECTRICALLY INSULATING MATERIAL, CIRCUIT BOARD AND METHOD FOR MANUFACTURING THE SAME
Attorney Docket Number::	10873.787USD1
Request For Early Publication::	No
Request For Non-Publication::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	7
Small Entity::	No
Latin Name::	
Variety Denomination Name::	
Petition Included::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers::	
Secrecy Order in Parent Appl.?::	No

Initial January 9, 2004

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Yoshihiro
Middle Name::	
Family Name::	KAWAKITA
Name Suffix::	
City of Residence::	Shijonawate-shi
State or Province of Residence::	Osaka
Country of Residence::	Japan
Street of mailing address::	10-3, Nakano-Honmachi
City of mailing address::	Shijonawate-shi
State or Province of mailing address::	Osaka
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	575-0051

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Daizo
Middle Name::	
Family Name::	ANDOH
Name Suffix::	
City of Residence::	Katano-shi
State or Province of Residence::	Osaka
Country of Residence::	Japan
Street of mailing address::	4-9-8, Hoshidanishi
City of mailing address::	Katano-shi
State or Province of mailing address::	Osaka
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	576-0015

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Fumio
Middle Name::	
Family Name::	ECHIGO
Name Suffix::	
City of Residence::	Osaka-shi
State or Province of Residence::	Osaka
Country of Residence::	Japan
Street of mailing address::	6-11-9-303, Toyosato, Higashiyodogawa-ku
City of mailing address::	Osaka-shi
State or Province of mailing address::	Osaka
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	533-0013

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Tadashi
Middle Name::	
Family Name::	NAKAMURA
Name Suffix::	
City of Residence::	Suita-shi
State or Province of Residence::	Osaka
Country of Residence::	Japan
Street of mailing address::	9-25-101, Naganonishi
City of mailing address::	Suita-shi
State or Province of mailing address::	Osaka
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	565-0817

Initial

January 9, 2004

Correspondence Information

Correspondence Customer Number:: 23552

Representative Information

Representative Customer Number::	23552
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Domestic Priority Information

Application::	Continuation Type::	Parent Application::	Parent Filing Date::
This application	Division of	09/956,205	September 18, 2001

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2000-282120	September 18, 2000	Yes

Assignee Information

Assignee Name:: MATSUSHITA ELECTRIC INDUSTRIAL CO.,
LTD.

Street of mailing address:: 1006 Oaza Kadoma

City of mailing address:: Kadoma-shi

State or Province of mailing address:: Osaka

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 571-8501

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